RM) = $7.9 \times (\text{number of hides})/\text{lbs of raw}$ material

TSS Adjustment (kg/kkg RM)=6.2×(number of hides)/kg of raw material (lb/1,000 lb RM) = $13.6 \times (number of hides)/lbs of raw mate$ rial

[51 FR 25001, July 9, 1986]

PART 433—METAL FINISHING POINT SOURCE CATEGORY

Subpart A-Metal Finishing Subcategory

Sec.

- 433.10 Applicability; description of the metal finishing point source category.
- 433.11 Specialized definitions.
- 433.12 Monitoring requirements
- 433.13 Effluent limitations representing the degree of effluent reduction attainable by applying the best practicable control technology currently available (BPT).
- 433.14 Effluent limitations representing the degree of effluent reduction attainable by applying the best available technology economically achievable (BAT).
- 433.15 Pretreatment standards for existing sources (PSES).
- 433.16 New source performance standards (NSPS).
- 433.17 Pretreatment standards for new sources (PSNS).

AUTHORITY: Secs. 301, 304(b), (c), (e), and (g), 306(b) and (c), 307(b) and (c), 308 and 501 $\,$ of the Clean Water Act (the Federal Water Pollution Control Act Amendments of 1971, as amended by the Clean Water Act of 1977) (the "Act"); 33 U.S.C. 1311, 1314(b) (c), (e), and (g), 1316(b) and (c), 1317(b) and (c), 1318 and 1361; 86 Stat. 816, Pub. L. 92-500; 91 Stat. 1567, Pub. L. 95-217.

SOURCE: 48 FR 32485, July 15, 1983, unless otherwise noted.

Subpart A—Metal Finishing Subcategory

§433.10 Applicability; description of the metal finishing point source category.

(a) Except as noted in paragraphs (b) and (c), of this section, the provisions of this subpart apply to plants which perform any of the following six metal finishing operations on any basis material: Electroplating, Electroless Plating, Anodizing, Coating (chromating, phosphating, and coloring), Chemical Etching and Milling, and Printed Circuit Board Manufacture. If any of those six operations are present, then this part applies to discharges from those

40 CFR Ch. I (7-1-03 Edition)

operations and also to discharges from any of the following 40 process operations: Cleaning, Machining, Grinding, Polishing, Tumbling, Burnishing, Impact Deformation, Pressure Deforma-tion, Shearing, Heat Treating, Thermal Cutting, Welding, Brazing, Soldering, Flame Spraying, Sand Blasting, Other Abrasive Jet Machining, Electric Discharge Machining, Ĕlectrochemical Machining, Electron Beam Machining, Laser Beam Machining, Plasma Arc Machining, Ultrasonic Machining, Sintering, Laminating, Hot Dip Coating, Sputtering, Vapor Plating, Thermal Infusion, Salt Bath Descaling, Solvent Degreasing, Paint Stripping, Painting, Electrostatic Painting, Electropainting, Vacuum Metalizing, Assembly, Calibration, Testing, and Mechanical Plating.

(b) In some cases effluent limitations and standards for the following industrial categories may be effective and applicable to wastewater discharges from the metal finishing operations listed above. In such cases these part 433 limits shall not apply and the following regulations shall apply:

Nonferrous metal smelting and refining (40 CFR part 421)

Coil coating (40 CFR part 465)

Porcelain enameling (40 CFR part 466)

Battery manufacturing (40 CFR part 461)

Iron and steel (40 CFR part 420)

Metal casting foundries (40 CFR part 464) Aluminum forming (40 CFR part 467) Copper forming (40 CFR part 468)

Plastic molding and forming (40 CFR part 463)

Nonferrous forming (40 CFR part 471)

Electrical and electronic components (40 CFR part 469)

(c) This part does not apply to:

(1) Metallic platemaking and gravure cylinder preparation conducted within or for printing and publishing facilities; and

(2) Existing indirect discharging job shops and independent printed circuit board manufacturers which are covered by 40 CFR part 413.)

[48 FR 32485, July 15, 1983; 48 FR 43682, Sept. 26, 1983; 48 FR 45105, Oct. 3, 1983; 51 FR 40421, Nov. 7, 1986]

§433.11 Specialized definitions.

The definitions set forth in $40\ {\rm CFR}$ part 401 and the chemical analysis methods set forth in 40 CFR part 136